

## 2-22 GHz Distributed Amplifier

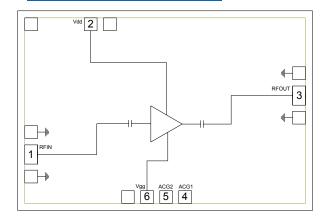
#### **Features**

- ► Ultra wideband performance
- ► Low noise figure
- ► Low current consumption
- ► Excellent return losses
- ► Small die size

### Description

The CMD241 is wideband GaAs MMIC distributed low noise amplifier die which operates from 2 to 22 GHz. The amplifier delivers 14 dB of gain with a corresponding noise figure of 2.3 dB and an output 1 dB compression point of +21 dBm at 11 GHz. The CMD241 is a 50 ohm matched design which eliminates the need for external DC blocks and RF port matching. The CMD241 offers full passivation for increased reliability and moisture protection.

### Functional Block Diagram



Electrical Performance - $V_{dd}$ = 5.0 V, $V_{gg}$ = -0.65 V, $T_A$ = 25 °C, $F$ = 11 GHz						
Parameter	Min	Тур	Max	Units		
Frequency Range	2 - 22			GHz		
Gain		14		dB		
Noise Figure		2.3		dB		
Input Return Loss		20		dB		
Output Return Loss		17		dB		
Output P1dB		21		dBm		
Output IP3		28		dBm		
Supply Current		74		mA		



## 2-22 GHz Distributed Amplifier

### **Specifications**

### **Absolute Maximum Ratings**

Parameter	Rating
Drain Voltage, Vdd	10 V
Gate Voltage, Vgg	-2.5 to 0 V
RF Input Power	+20 dBm
Channel Temperature, Tch	150 °C
Power Dissipation, Pdiss	1.75 W
Thermal Resistance, $\Theta$ <sub>JC</sub>	37 °C/W
Operating Temperature	-55 to 85 °C
Storage Temperature	-55 to 150 °C

Exceeding any one or combination of the maximum ratings may cause permanent damage to the device.

### **Recommended Operating Conditions**

Parameter	Min	Тур	Max	Units
Vdd	5.0	5.0	8.0	V
Idd		74		mA
Vgg		-0.65		V

Electrical performance is measured at specific test conditions. Electrical specifications are not guaranteed over all recommended operating conditions.

### Electrical Specifications, $V_{dd} = 5.0 \text{ V}$ , $V_{gg} = -0.65 \text{ V}$ , $T_A = 25 \, ^{\circ}\text{C}$

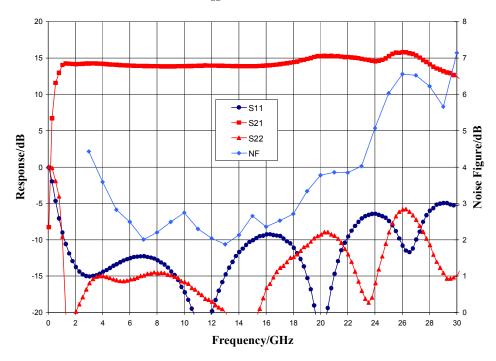
Parameter	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
Frequency Range		2 - 6			6 - 18			18 - 22		GHz
Gain	11	14		10.5	13.5		11	15		dB
Noise Figure		3.5			2.5			3.75		dB
Input Return Loss		13			13			15		dB
Output Return Loss		15			14			10		dB
Output P1dB	16	20		14	18		14	17		dBm
Output IP3		29			28			25		dBm
Supply Current	50	74	100	50	74	100	50	74	100	mA
Gain Temperature Coefficient		0.004			0.006			0.007		dB/°C
Noise Figure Temperature Coefficient		0.01			0.009			0.014		dB/°C



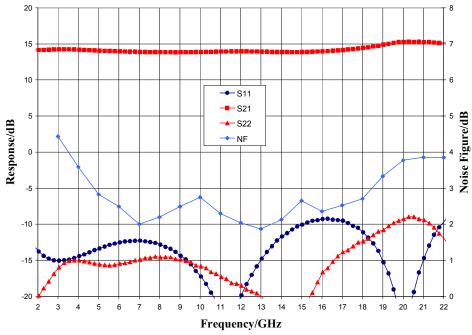
## 2-22 GHz Distributed Amplifier

### Typical Performance

Broadband Performance,  $V_{dd} = 5.0 \text{ V}$ ,  $V_{gg} = -0.65 \text{ V}$ ,  $I_{dd} = 74 \text{ mA}$ ,  $T_A = 25$ 

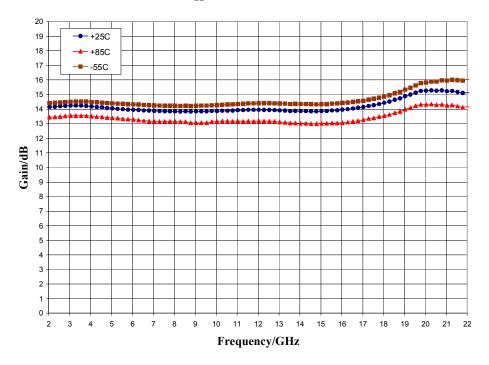


Narrow-band Performance,  $V_{dd}$  = 5.0 V,  $V_{gg}$  = -0.65 V,  $I_{dd}$  = 74 mA,  $T_A$  = 25

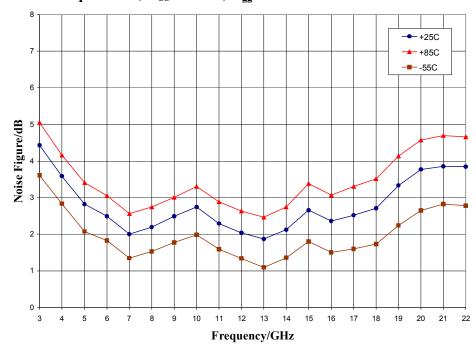


### Typical Performance

### Gain vs. Temperature, $V_{dd} = 5.0 \text{ V}$ , $V_{gg} = -0.65 \text{ V}$



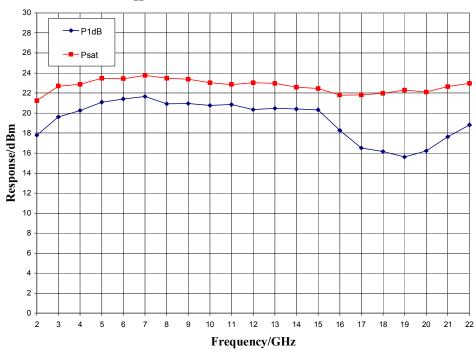
## Noise Figure vs. Temperature, $V_{dd}$ = 5.0 V, $V_{gg}$ = -0.65 V



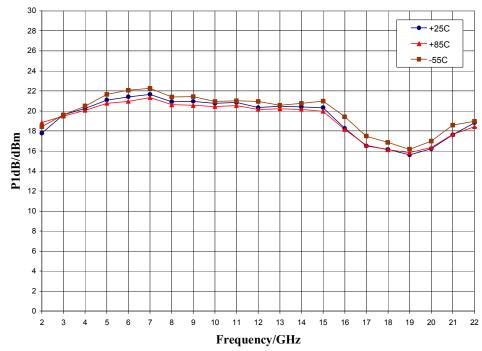
# 2-22 GHz Distributed Amplifier

### Typical Performance

Output Power,  $V_{dd} = 5.0 \text{ V}$ ,  $V_{gg} = -0.65 \text{ V}$ ,  $T_A = 25 \text{ }^{\circ}\text{C}$ 



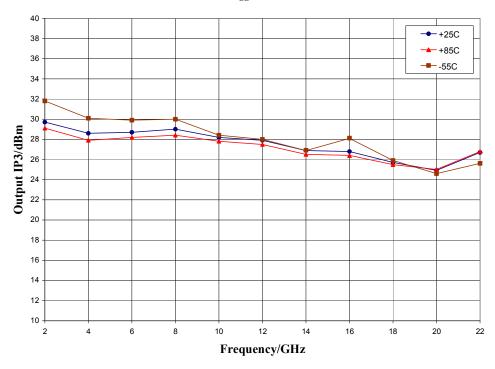
P1dB vs. Temperature,  $V_{dd}$  = 5.0 V,  $V_{gg}$  = -0.65 V



# 2-22 GHz Distributed Amplifier

### Typical Performance

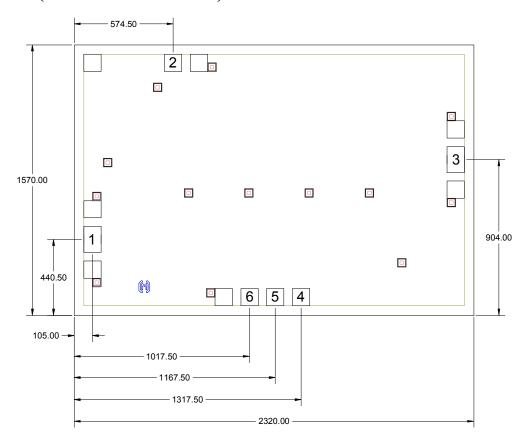
### Output IP3 vs. Temperature, $V_{dd} = 5.0 \text{ V}$ , $V_{gg} = -0.65 \text{ V}$ , $T_A = 25 \, ^{\circ}\text{C}$



## 2-22 GHz Distributed Amplifier

### Mechanical Information

#### Die Outline (all dimensions in microns)



#### Notes:

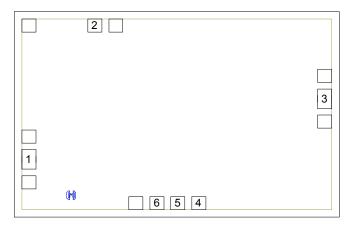
- 1. No connection required for unlabeled pads
- 2. Backside is RF and DC ground
- 3. Backside and bond pad metal: Gold
- 4. Die is 70 microns thick
- 5. DC bond pads (2, 4, 5, 6) are 100 x 100 microns
- 6. RF bond pads (1, 3) are 100 x 150 microns



# 2-22 GHz Distributed Amplifier

## Pad Description

### **Pad Diagram**



### **Functional Description**

Pad	Function	Description	Schematic
1	RF in	DC blocked and 50 ohm matched	RF in O
2	Vdd	Power supply voltage Decoupling and bypass caps required	Vdd
3	RF out	DC blocked and 50 ohm matched	
4, 5	ACG1, 2	Low Frequency Termination Attach bypass capacitor per application circuit	ACG2 O RF out
6	Vgg	Power supply voltage Decoupling and bypass caps required	Vgg
Backside	Ground	Connect to RF / DC ground	GND =

## 2-22 GHz Distributed Amplifier

#### Applications Information

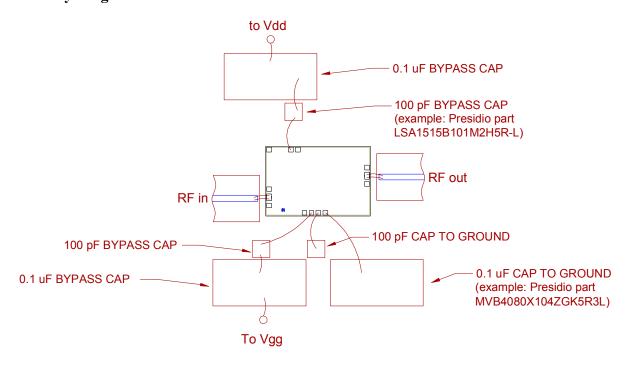
#### **Assembly Guidelines**

The backside of the CMD241 is RF ground. Die attach should be accomplished with electrically and thermally conductive epoxy or eutectic attach. Standard assembly procedures should be followed for high frequency devices. The top surface of the semiconductor should be made planar to the adjacent RF transmission lines, and the RF decoupling capacitors placed in close proximity to the DC connections on chip.

RF connections should be made as short as possible to reduce the inductive effect of the bond wire. Use of a 0.8 mil thermosonic wedge bonding is highly recommended as the loop height will be minimized. The RF input and output require a double bond wire as shown.

The semiconductor is 70 um thick and should be handled by the sides of the die or with a custom collet. Do not make contact directly with the die surface as this will damage the monolithic circuitry. Handle with care.

#### **Assembly Diagram**

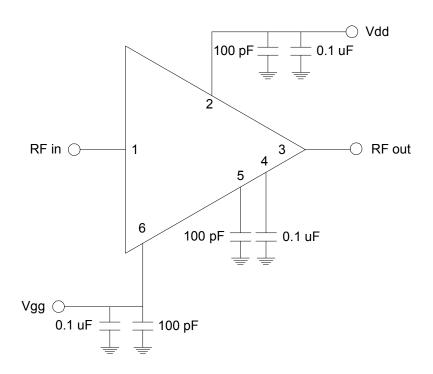


GaAs MMIC devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.



### Applications Information

#### **Application Circuit**



#### **Biasing and Operation**

The CMD241 is biased with a positive drain supply and a negative gate supply. Performance is optimized when the drain voltage is set to +5.0 V. The nominal gate voltage is -0.65 V.

#### Turn ON procedure:

- 1. Apply gate voltage  $V_{\rm gg}$  and set to -2 V
- 2. Apply drain voltage V<sub>dd</sub> and set to +5 V
- 3. Increase  $V_{gg}$  (less negative) to achieve a drain current of 74 mA

#### Turn OFF procedure:

- 1. Turn off drain voltage V<sub>dd</sub>
- 2. Turn off gate voltage  $V_{\rm gg}$

RF power can be applied at any time.

### **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Amplifier category:

Click to view products by Qorvo manufacturer:

Other Similar products are found below:

A82-1 BGA622H6820XTSA1 BGA 728L7 E6327 BGB719N7ESDE6327XTMA1 HMC397-SX HMC405 HMC561-SX HMC8120-SX HMC8121-SX HMC-ALH382-SX HMC-ALH476-SX SE2433T-R SMA3101-TL-E SMA39 A66-1 A66-3 A67-1 A81-2 LX5535LQ LX5540LL MAAM02350 HMC3653LP3BETR HMC549MS8GETR HMC-ALH435-SX SMA101 SMA32 SMA411 SMA531 SST12LP19E-QX6E WPM0510A HMC5929LS6TR HMC5879LS7TR HMC1087F10 HMC1086 HMC1016 SMA1212 MAX2689EWS+T MAAMSS0041TR MAAM37000-A1G LTC6430AIUF-15#PBF SMA70-2 SMA4011 A231 HMC-AUH232 LX5511LQ LX5511LQ-TR HMC7441-SX HMC-ALH310 XD1001-BD-000V A4011